

X006

0.8 A sensitive gate SCRs

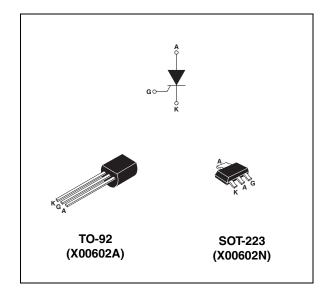
Features

- I_{T(RMS)} = 0.8 A
- $V_{DRM}/V_{RRM} = 600 V$
- I_{GT} = 200 μA

Description

Thanks to highly sensitive triggering levels, the X006 SCR series is suitable for all applications where the available gate current is limited, such as ground fault circuit interrupters, overvoltage crowbar protection in low power supplies, capacitive ignition circuits, etc.

Available in though-hole or surface-mount packages, these devices are optimized in forward voltage drop and inrush current capabilities, for reduced power losses and high reliability in harsh environments.



1/9

1 Characteristics

Symbol	Parameter				Unit
I	PMS on otato ourrent (190 °Conduction angle)	TO-92	T _I = 85 °C	0.9	٨
I _{T(RMS)}	RMS on-state current (180 °Conduction angle)	SOT-223	T _{tab} = 100 °C	0.8	A
ІТ	Average on state surrent (190 °Conduction angle)	TO-92	T _I = 85 °C	0.5	A
IT _(AV)	Average on-state current (180 °Conduction angle)	SOT-223	$T_{tab} = 100 \ ^{\circ}C$		
I	Non repetitive surge peak on-state current	t _p = 8.3 ms	– T _i = 25 °C	10	А
ITSM	Non repetitive surge peak on-state current	t _p = 10 ms	1j=25 0	9	
l²t	I ² t Value for fusing	t _p = 10 ms	T _j = 25 °C	0.4	A ² s
dl/dt	Critical rate of rise of on-state current I_G = 2 x I_{GT} , t_r \leq 100 ns	F = 60 Hz	T _j = 125 °C	50	A/µs
I _{GM}	Peak gate current $t_p = 20 \ \mu s$ $T_j = 1$		T _j = 125 °C	1	А
P _{G(AV)}	Average gate power dissipation	0.1	W		
T _{stg} T _j	Storage junction temperature range Operating junction temperature range				°C

 Table 1.
 Absolute ratings (limiting values)

Table 2. Electrical characteristics

Symbol	Test Conditions			Value	Unit	
1			MIN.	15		
I _{GT}	$V_{\rm D}$ = 12 V, R _L = 140 Ω			200	μA	
V _{GT}			MAX.	0.8	V	
V_{GD}	V_D = $V_{DRM,}~R_L$ = 3.3 k Ω , R_{GK} = 1 k Ω	T _j = 125 °C	MIN.	0.2	V	
V _{RG}	Ι _{RG} = 10 μΑ		MIN.	5	V	
Ι _Η	$I_T = 50 \text{ mA}, \text{ R}_{GK} = 1 \text{ k}\Omega$		MAX.	5	mA	
١L	$I_{G} = 1 \text{ mA}, R_{GK} = 1 \text{ k}\Omega$		MAX.	6	mA	
dV/dt	$V_D = 67\% V_{DRM} R_{GK} = 1 k\Omega$	T _j = 125 °C	MIN.	25	V/µs	
V_{TM}	I _{TM} = 1 A, tp = 380 μs	T _j = 25 °C	MAX.	1.35	V	
V _{t0}	Threshold voltage	T _j = 125 °C	MAX.	0.85	V	
R _d	Dynamic resistance $T_j = 125 \text{ °C}$		MAX.	245	mΩ	
I _{DRM}		T _j = 25 °C	MAX.	1		
I _{RRM}	$V_{\text{DRM}} = V_{\text{RRM}}, R_{\text{GK}} = 1 \text{ k}\Omega$	T _j = 125 °C	MAX.	100	μΑ	

Symbol	Parameter			Value	Unit
P	lunction to empiont (DC)		TO-92	150	
R _{th(j-a)}	Junction to ambient (DC)	$S = 5 \text{ cm}^2$	SOT-223	60	°C/W
R _{th(j-l)}	Junction to lead (DC)		TO-92	70	0.00
R _{th(j-t)}	Junction to tab (DC)		SOT-223	30	1

Table 3.Thermal resistances

Figure 1. Maximum average power Figure 2. dissipation versus average on-state current

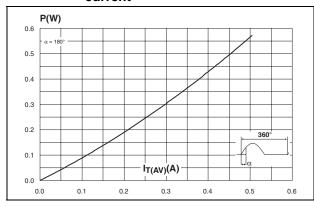
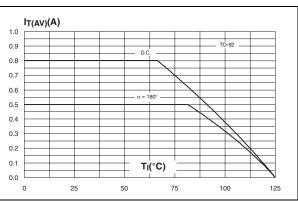


Figure 3. Average and D.C. on-state current Figure 4. versus ambient temperature (epoxy printed circuit board FR4, copper thickness = $35 \ \mu m$, $S_{CU} = 0.5 \ cm^2$) (TO-92)





Average and DC on-state current versus case temperature (SOT-223)

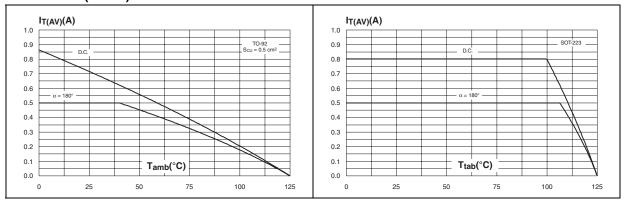


Figure 5. Average and DC on-state current Figure 6. versus ambient temperature (epoxy PCB FR4, copper thickness = $35 \mu m$, $S_{CU} = 5 cm^2$) (SOT-223)

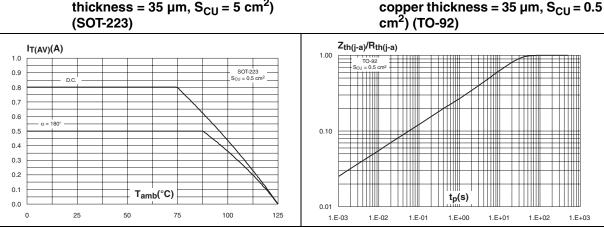


Figure 8.

Figure 7. Relative variation of thermal impedance junction to ambient versus pulse duration (PCB FR4, copper thickness = 35 μm, S_{CU} = 0.5 cm²) (SOT-223)

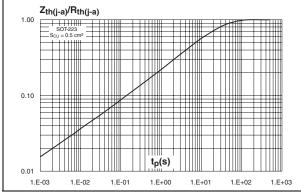


Figure 9. Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values)

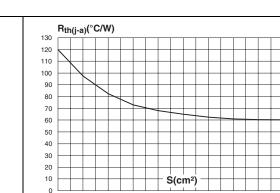
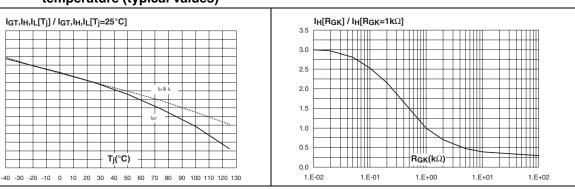


Figure 10. Relative variation of holding current versus gate-cathode resistance (typical values)



0.0 0.5 1.0 1.5 2.0 2.5 3.0 3.5 4.0 4.5 5.0

Relative variation of thermal

impedance junction to ambient

Thermal resistance junction to

ambient versus copper surface

under tab (PCB FR4, copper

thickness = $35 \mu m$) (SOT-223)

versus pulse duration (PCB FR4,



1.6 1.4

1.2

1.0

0.8

0.6

0.4

0.2

0.0

10

Figure 11. Relative variation of dV/dt immunity Figure 12. versus gate-cathode resistance (typical values)

dV/dt[R_{GK}] / dV/dt[R_{GK}=1kΩ]

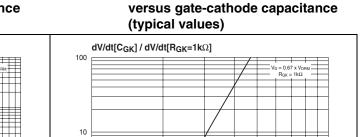


Figure 13. Surge peak on-state current versus Figure 14. number of cycles

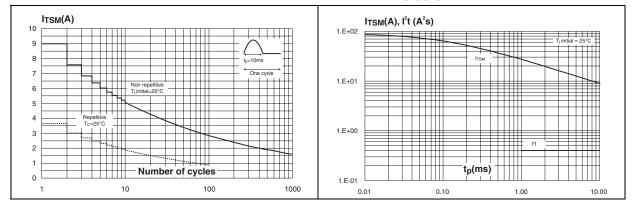
 $R_{GK}(k\Omega)$

1.0E+00

Non repetitive surge peak on-state current for a sinusoidal pulse with width $t_P < 10ms$, and corresponding value of l^2t

CGK(nF)

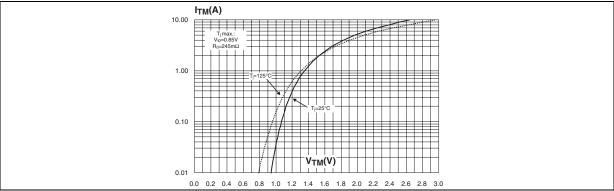
Relative variation of dV/dt immunity



1.0E+01

1

Figure 15. On-state characteristics (maximum values)



100.0

10.0

1.0

0.1 1.0E-01

57

2 Ordering information scheme

Figure 16	Ordering	information	scheme
i iguic io	. oracing	mormation	Seneme

Current 006 = 0.8 A Sensitivity $02 = 200 \ \mu\text{A}$ Voltage $M = 600 \ \text{V}$ Package A = TO-92 (A"Blank") N = SOT-223 (N"No Blank") Packing mode 1AA2 = Bulk 2AL2 = Ammopack	Sensitive SCR series	X 006 02 M Z _{Blank} 1AA2
Voltage M = 600 V Package A = TO-92 (A"Blank") N = SOT-223 (N"No Blank") Packing mode 1AA2 = Bulk 2AL2 = Ammopack	Current	
02 = 200 µA Voltage M = 600 V Package A = TO-92 (A"Blank") N = SOT-223 (N"No Blank") Packing mode 1AA2 = Bulk 2AL2 = Ammopack	006 = 0.8 A	
M = 600 V Package A = TO-92 (A"Blank") N = SOT-223 (N"No Blank") Packing mode	Sensitivity	
M = 600 V Package A = TO-92 (A"Blank") N = SOT-223 (N"No Blank") Packing mode 1AA2 = Bulk 2AL2 = Ammopack	02 = 200 μA	
Package A = TO-92 (A"Blank") N = SOT-223 (N"No Blank") Packing mode 1AA2 = Bulk 2AL2 = Ammopack	Voltage	
A = TO-92 (A"Blank") N = SOT-223 (N"No Blank") Packing mode 1AA2 = Bulk 2AL2 = Ammopack	M = 600 V	
N = SOT-223 (N"No Blank") Packing mode 1AA2 = Bulk 2AL2 = Ammopack	Package	
Packing mode 1AA2 = Bulk 2AL2 = Ammopack		
1AA2 = Bulk 2AL2 = Ammopack	N = SOT-223 (N"No Blank")	
2AL2 = Ammopack		
$\Delta ALZ = IADE \alpha [EEI (IO-9Z)]$		
5BA4 = Tape & reel (SOT-223)	,	



3 Package information

• Epoxy meets UL94, V0

In order to meet environmental requirements, ST offers these devices in ECOPACK[®] packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at *www.st.com*.

Table 4.TO-92 (plastic) dimensions

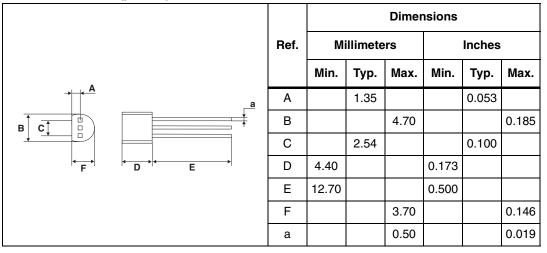
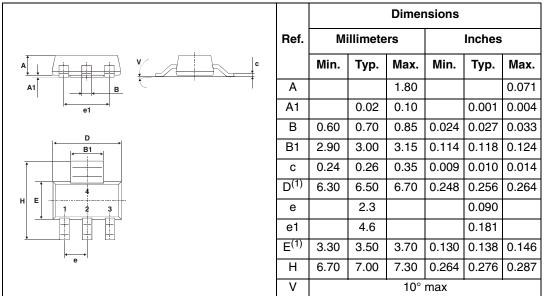


Table 5.SOT-223 dimensions



1. Do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm (0.006inches)



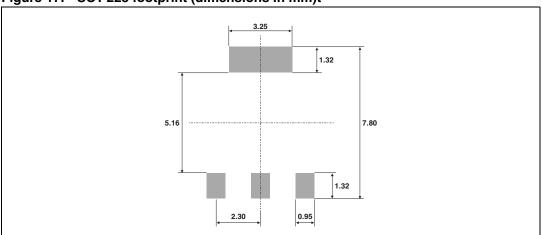


Figure 17. SOT-223 footprint (dimensions in mm)t

4 Ordering information

Table 6.Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode	
X00602MA 1AA2				2500	Bulk	
X00602MA 2AL2	X0602 MA	TO-92	0.2 g	2000	Ammopack	
X00602MA 5AL2				2000	Tape and reel	
X00602MN5BA4	X06 2M	SOT-223	0.12 g	1000	Tape and reel	

5 Revision history

Table 7. Document revision history

Date	Revision	Changes
Jan-2002	3	Last update.
08-Aug-2006	4	SOT-223 package added.
1-Apr-2008	5	Reformatted to current standards. Device X00605 removed. Updated dimensions in <i>Table 5</i> .

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